

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung
Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.:

FILED: Herewith

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER FOIL
MANUFACTURED THEREBY

APPLICATION DATA SHEET UNDER 37 C.F.R. § 1.76

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

BIBLIOGRAPHIC DATA

1. Applicant Information (LARGE ENTITY)

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2. Correspondence Information

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3. Application Information

Title: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED
COPPER FOIL MANUFACTURED THEREBY

Docket No.: 1772-5

Suggested Classification

Class:

SubClass:

Tech Center to which subject matter is assigned:

Total Number of Drawings Sheets: 2

Type of Application:

X Utility

X application to be published

suggested drawing figure for publication: 1

☐ application is not to be published.
☐ Design

Secrecy order under § 5.2:

This application

☒ does not disclose

☐ discloses a significant part of the
subject matter of an application which is under a secrecy order
pursuant to § 5.2.

4. Representative Information

The following have a power of attorney or authorization of agent in this application:

Name: John S. Egbert, Reg. No. 30,627
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Customer No.: 24106

5. Domestic Priority Information

Domestic priority for this application is claimed as follows:

Not Applicable.

6. Foreign Priority Information

Foreign priority is claimed for this application as follows:

Country: Republic of Korea
Appn No.: 10-2002-0075411
Filing Date: 29 November 2002
Status:

7. Assignee information (LARGE ENTITY)

The Assignee of this application is:

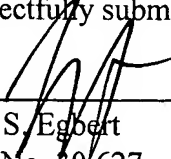
Name: LG CABLE LTD.
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Extent of interest of Assignee in application: 100%

11.21.03
Date

Customer No. 24106

Respectfully submitted,



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